



Product Change Notification

Change Notification #: 115656 - 00

Change Title: Intel® Server Chassis H2000G Product Family, PCN 115656-00, Label, Chassis and Carton Box Labels update

Date of Publication: July 06, 2017

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jul 21, 2017
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Description of Change to the Customer:

The Intel® Server Chassis H2000G Product Family listed in the “Products Affected/Intel Ordering Codes” table will undergo the following changes on the Chassis and Carton Box labels:

- a) Bureau of Standards, Metrology and Inspection (BSMI) mark updated with the Restriction of the Use of Certain Hazardous Substances (ROHS) mark

Please refer to the “Products Affected/Intel Ordering Codes” table below for a summary of TA changes.

Figure 1. Current Chassis Label



Figure 2. New Chassis Label



Figure 3. Current Carton Box Label



Figure 4. New Carton Box Label



Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
H2216XXKR2	933688	H20866-011	H20866-012
H2312XXKR2	933689	H20865-011	H20865-012
H2312XXLR2	942352	J17277-005	J17277-006
H2216XXLR2	942353	H95607-005	H95607-006
H2224XXKR2	943478	H70096-008	H70096-009
H2224XXLR2	943577	H96144-004	H96144-005

PCN Revision History:

Date of Revision: July 6, 2017	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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